



SAS-3 RIGHT ANGLE SURFACE MOUNT CONNECTOR

BOARD ROUTING RECOMMENDATIONS

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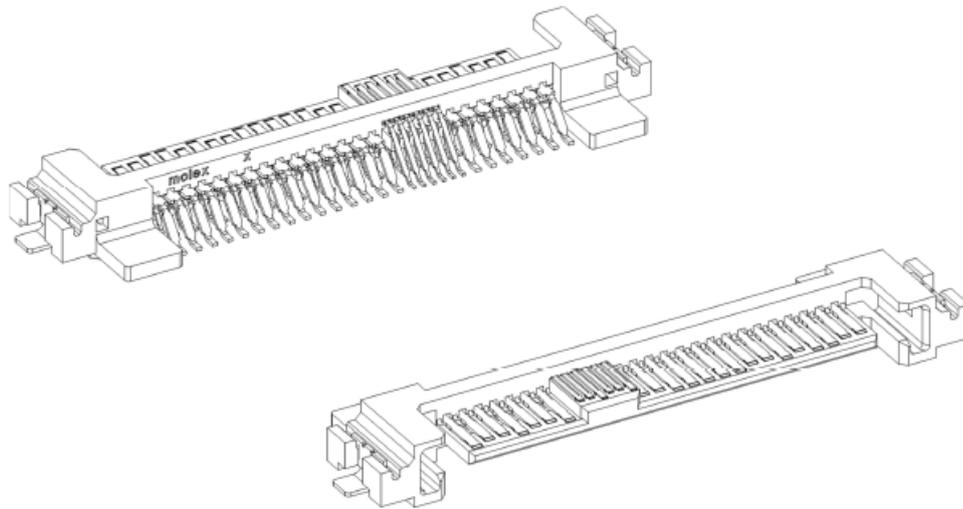
SAS-3 RIGHT ANGLE SURFACE MOUNT CONNECTOR

BOARD ROUTING RECOMMENDATIONS

1.0 SCOPE

This specification covers the high-speed PCB routing recommendations of high-speed signals at primary and secondary ports for 78758 series connector. The connector is a right angle surface mount type. The pins of the connector are soldered for mechanical retention to the PC board.

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2.0 PC BOARD REQUIREMENTS

2.1 MATERIAL THICKNESS

The recommended PC board thickness shall be 0.82mm. High performance low loss PC board material is recommended.

2.2 LAYOUT

The solder pads for the connector assembly must be precisely located to ensure proper placement and optimum performance of the connector assembly. Refer to the applicable Sales Drawing for the recommended solder pad pattern, dimensions and tolerances.

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3.0 HIGH-SPEED ROUTING

3.1 TRACE TO PAD ATTACHMENT (FOR BOTH MICROSTRIP AND STRIPLINE ROUTING)

There are several ways to connect the traces to their corresponding signal pads. Two possible methods are illustrated in Figures 1 and 2.

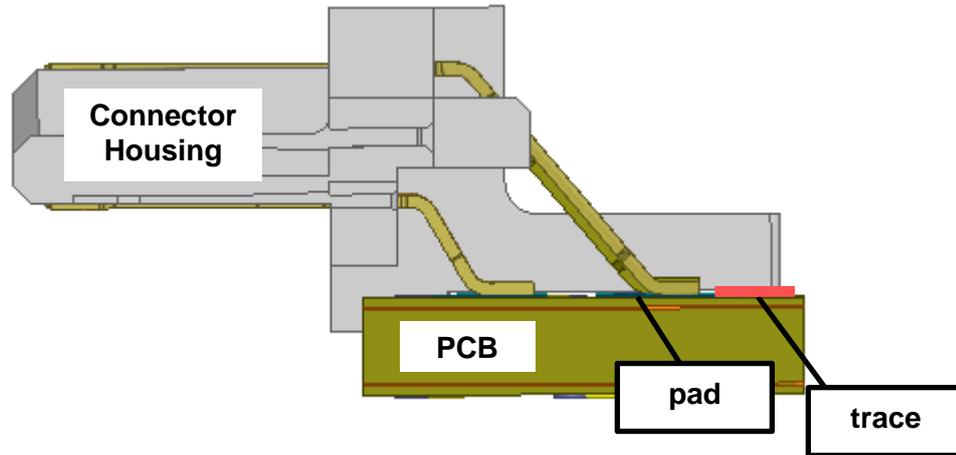


Figure 1

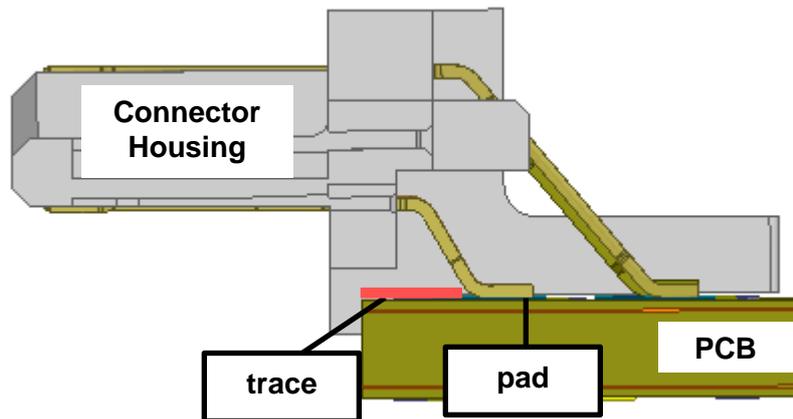


Figure 2

As seen in Figure 1, trace routed outwards from pad of connector will result in minimum pad stub while worst case pad stub occurs when trace is routed inwards as shown in Figure 2.

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3.2 GROUND VIA PLACEMENT

PCB Top View

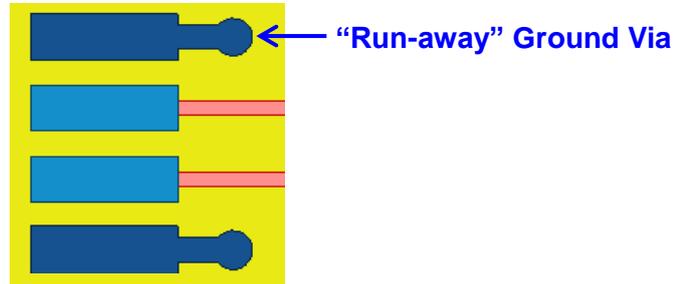


Figure 3

As seen in Figure 3, “run-away” ground vias from ground pads should follow the direction where the signal traces were attached to their corresponding signal pads.

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3.3 IMPEDANCE MATCHING AT TRACE AND FOOTPRINT/PAD

Impedance matching is critical to improve and optimize SI performance.

All traces and pad should design to the intended system impedance. For SAS application, it should be single-ended 50Ω or differential 100Ω. For PCI-Express application, it should be single-ended 42.5Ω or differential 85Ω.

This could be done by controlling distance between trace (H_{trace}) and pad (H_{pad}) with reference to their ground return. This is illustrated in Figure 4.

When the trace width of pad equals to trace, H_{trace} equals H_{pad} . If pad width is wider than trace, $H_{pad} > H_{trace}$. This is to eliminate excessive capacitive coupling at pad region.

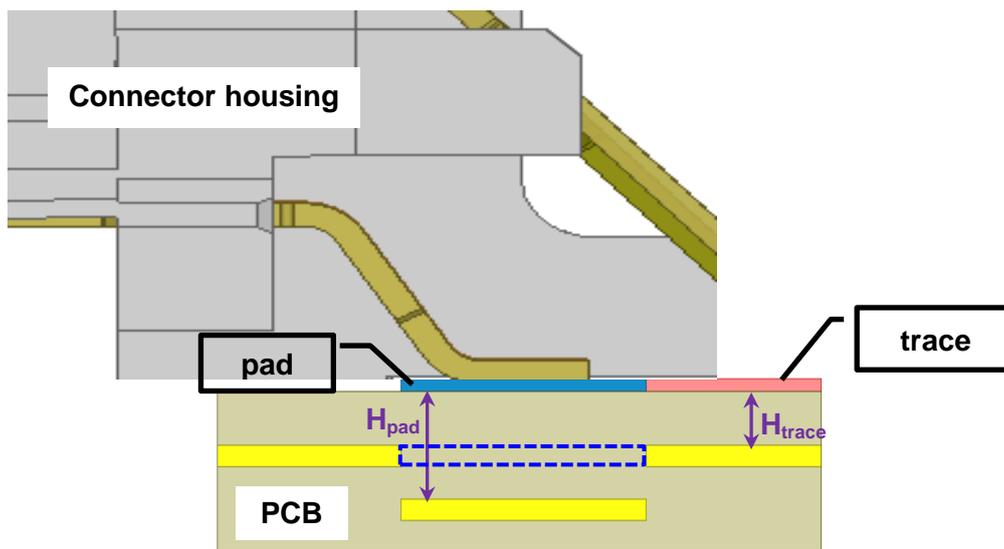


Figure 4

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3.4 HIGH SPEED REFERENCE PLANE ANTI-PAD

An antipad or copper cutout region, shown in Figure 5, is needed to obtain desirable H_{pad} for impedance optimization. A table containing suggested values for primary and secondary ports are shown in Table 1.

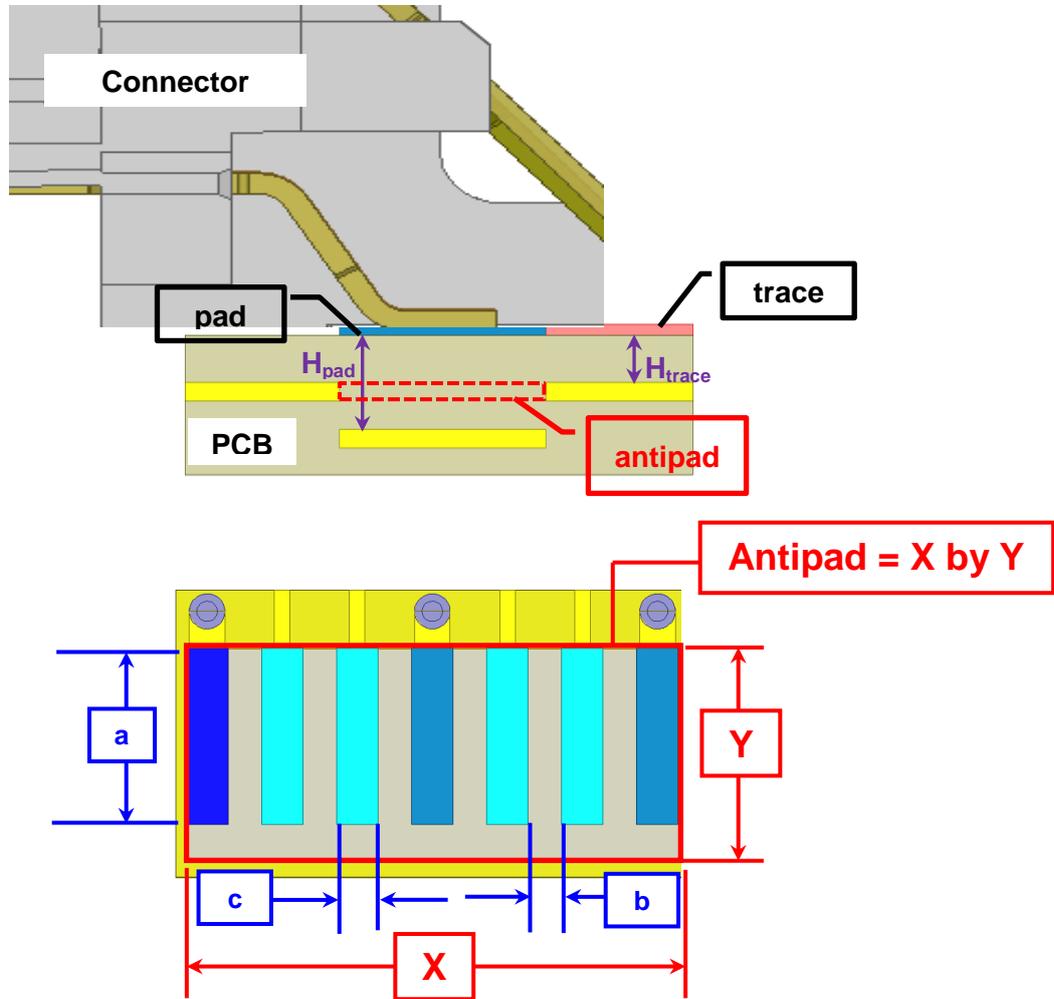


Figure 5 – Port Footprint

Antipad Dimension	Primary	Secondary
X	$7c + 6b$	$7c + 6b$
Y	a	a + b

Table 1

Note: Anti-pad was implemented for impedance matching. Dimensions can vary from recommendation to meet electrical requirements. For example, the anti-pad can be made larger with a broader keep-out region on non-signal ground planes to minimize parasitic capacitance.

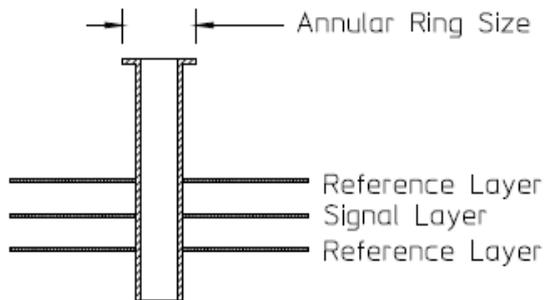
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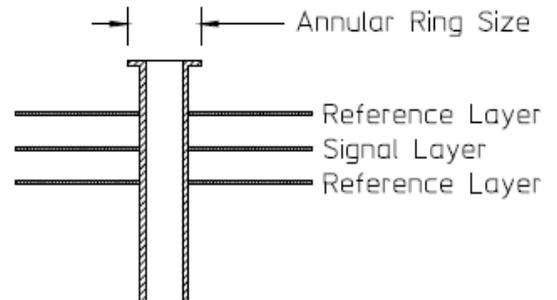
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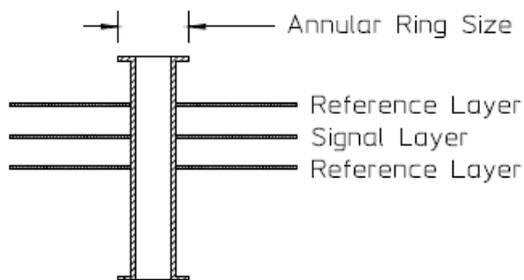
3.5 SIGNAL THROUGH-HOLE VIA STUBS (FOR STRIPLINE ROUTING)



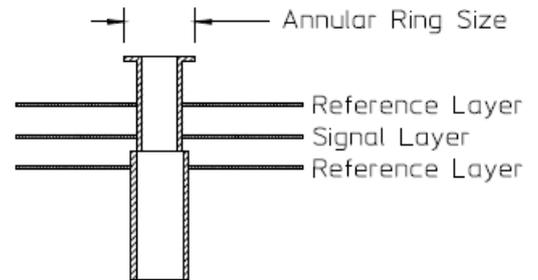
**Bottom Launch
Driven Via
(Preferred)**



**Top Launch
Stub Via
(Worst Case)**



Standard Via Configuration



Back Drill To Minimize Stub

Only the signal reference ground planes are shown above and only two annular rings are required for retention of the through-hole via within the printed circuit board. Non-functional annular rings should be removed for unassociated signal layers.

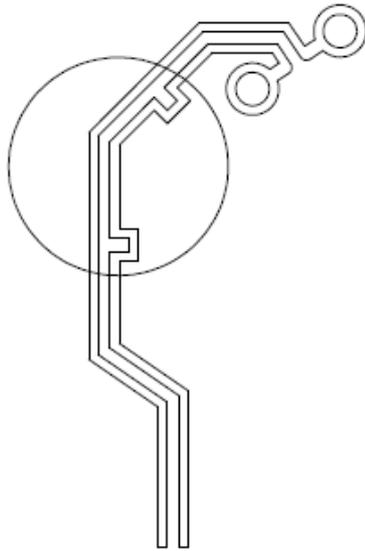
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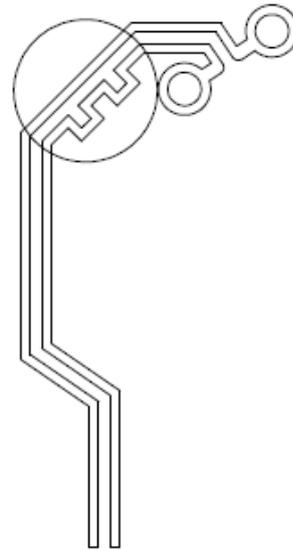
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3.6 SKEW COMPENSATION FOR DIFFERENTIAL ROUTING



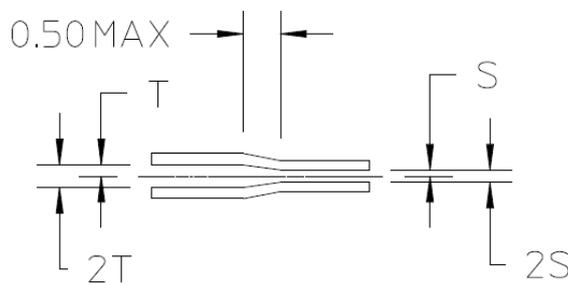
PREFERRED



NOT RECOMMENDED

It is recommended that skew compensation be distributed verses grouped in one or more locations.

3.7 TRACE COMPARISON



TRANSITION SHOULD BE SYMMETRIC

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